

High Temperature Silicon Carbide Power Schottky Diode

Features

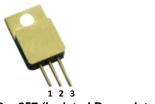
- 1200 V Schottky rectifier
- 250 °C maximum operating temperature
- Electrically isolated base-plate
- Zero reverse recovery charge
- Superior surge current capability
- Positive temperature coefficient of V_{F}
- Temperature independent switching behavior
- Lowest figure of merit Q_C/I_F
- Available screened to Mil-PRF-19500

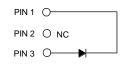
Advantages

- High temperature operation
- Improved circuit efficiency (Lower overall cost)
- · Low switching losses
- Ease of paralleling devices without thermal runaway
- Smaller heat sink requirements
- Industry's lowest reverse recovery charge
- Industry's lowest device capacitance
- Ideal for output switching of power supplies
- Best in class reverse leakage current at operating temperature

Maximum Ratings at T_j = 250 °C, unless otherwise specified

Package RoHS Compliant





TO – 257 (Isolated Base-plate Hermetic Package)

V_{RRM}

 Q_{c}

I_{F (Tc=25°C)}

Applications

- Down Hole Oil Drilling
- Geothermal Instrumentation
- Solenoid Actuators
- General Purpose High-Temperature Switching
- Amplifiers
- Solar Inverters
- Switched-Mode Power Supply (SMPS)
- Power Factor Correction (PFC)

Parameter	Symbol	Conditions	Values	Unit
Repetitive peak reverse voltage	V _{RRM}		1200	V
Continuous forward current	I _F	T _C = 25 °C	8	А
Continuous forward current	I _F	T _C ≤ 225 °C	2.5	А
RMS forward current	I _{F(RMS)}	T _C ≤ 225 °C	4.3	А
Surge non-repetitive forward current, Half Sine Wave	I _{F,SM}	$T_{C} = 25 \ ^{\circ}C, t_{P} = 10 \ ms$	30	А
Non-repetitive peak forward current	I _{F,max}	T _C = 25 °C, t _P = 10 μs	120	А
² t value	∫i² dt	T _C = 25 °C, t _P = 10 ms	5	A ² S
Power dissipation	P _{tot}	T _C = 25 °C	66	W
Operating and storage temperature	T _i , T _{stq}		-55 to 250	°C

Electrical Characteristics at T_j = 250 °C, unless otherwise specified

Parameter	Symbol	Conditions –		Values			Unit
Parameter	Symbol			min.	typ.	max.	Unit
Diode forward voltage	V _F	I _F = 2.5 A, T _j = 25 °C I _F = 2.5 A, T _j = 250 °C		1.6 2.8		V	
Reverse current	I _R	V _R = 1200 V, T _j = 25 °C V _R = 1200 V, T _j = 250 °C		1 25	10 200	μA	
Total capacitive charge	Q _c	$ _{F} \leq _{F,MAX}$	V _R = 400 V V _R = 960 V		17 29		nC
Switching time	ts	dI _F /dt = 200 A/μs T _j = 210 °C	V _R = 400 V V _R = 960 V		< 25		ns
Total capacitance	С	$V_R = 1 V, f = 1 MHz,$ $V_R = 400 V, f = 1 MHz$ $V_R = 1000 V, f = 1 MHz$	z, T _j = 25 °C		237 25 20		pF

Thermal Characteristics

Thermal resistance, junction - case	R _{thJC}	3.4	°C/W
Mechanical Properties			
Mounting torque	М	0.6	Nm

1N8026-GA

8 A

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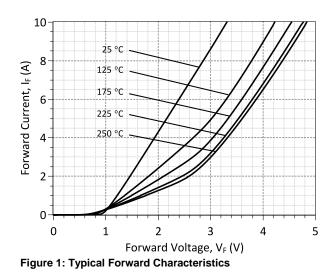
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1200 V

17 nC

GeneSic SEMICONDUCTOR

1N8026-GA



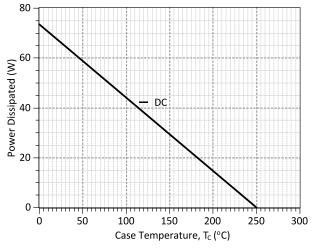
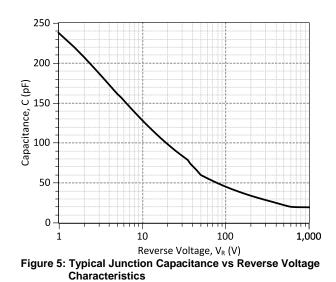


Figure 3: Power Derating Curve



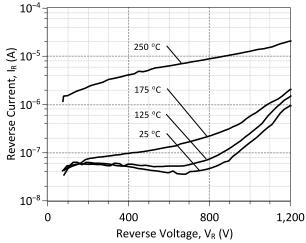
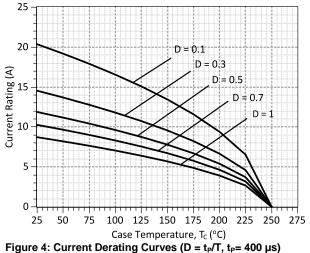
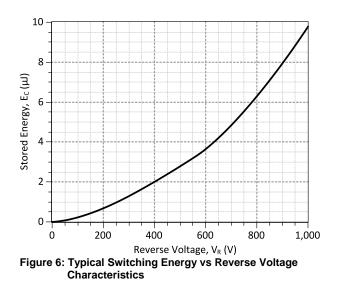


Figure 2: Typical Reverse Characteristics

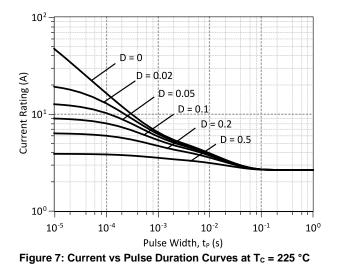


(Considering worst case Z_{th} conditions)





1N8026-GA



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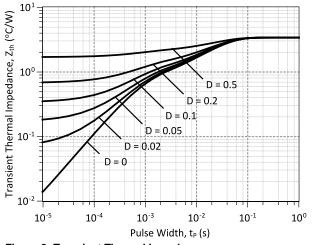
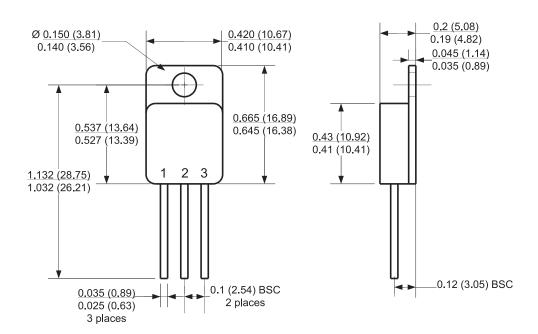


Figure 8: Transient Thermal Impedance

Package Dimensions:



PACKAGE OUTLINE



NOTE

1. CONTROLLED DIMENSION IS INCH. DIMENSION IN BRACKET IS MILLIMETER.

2. DIMENSIONS DO NOT INCLUDE END FLASH, MOLD FLASH, MATERIAL PROTRUSIONS



Revision History					
Date	Revision	Comments	Supersedes		
2014/08/26	1	Updated Electrical Characteristics			
2012/04/24	0	Initial release			

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SPICE Model Parameters

This is a secure document. Copy this code from the SPICE model PDF file on our website into a SPICE software program for simulation of the 1N8026-GA.

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*
     MODEL OF GeneSiC Semiconductor Inc.
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*
     $Revision: 1.0
                                 $
*
     $Date: 05-SEP-2013
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*
*
     GeneSiC Semiconductor Inc.
*
     43670 Trade Center Place Ste. 155
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     Dulles, VA 20166
*
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*
* These models are provided "AS IS, WHERE IS, AND WITH NO WARRANTY
* OF ANY KIND EITHER EXPRESSED OR IMPLIED, INCLUDING BUT NOT LIMITED
* TO ANY IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A
* PARTICULAR PURPOSE."
* Models accurate up to 2 times rated drain current.
*
* Start of 1N8026-GA SPICE Model
.SUBCKT 1N8026 ANODE KATHODE
R1 ANODE INT R=((TEMP-24) *0.0021); Temperature Dependant Resistor
D1 INT KATHODE 1N8026 25C; Call the 25C Diode Model
D2 ANODE KATHODE 1N80\overline{2}6 PIN; Call the PiN Diode Model
.MODEL 1N8026 25C D
          4.45E-15
+ IS
                                      0.206
                           RS
          1.18144
                                      112.92
+ N
                           IKF
+ EG
          1.2
                           XTI
                                       3
          3.00E-10
                                      0.419
+ CJO
                           VJ
+ M
          1.6
                           FC
                                      0.5
+ TT
          1.00E-10
                                      1200
                           ΒV
         1.00E-03
                                      1200
+ IBV
                           VPK
                                      SiC Schottky
+ IAVE
          5
                           TYPE
+ MFG
          GeneSiC Semiconductor
.MODEL 1N8026 PIN D
          2.93E-12
+ IS
                           RS
                                      0.35326
+ N
          4.6113
                                      0.0043236
                           IKF
+ EG
          3.23
                          XTI
                                      60
          0.5
                           TΤ
+ FC
                                      0
+ BV
          1200
                                      1.00E-03
                           IBV
+ VPK
          1200
                           IAVE
                                      2.5
+ TYPE
         SiC PiN
.ENDS
* End of 1N8026-GA SPICE Model
```